

LY3200ALH

MEMS motion sensor:

high performance ±2000 dps analog yaw-rate gyroscope

Features

- 2.7 V to 3.6 V single supply operation
- Wide extended operating temperature range (-40°C to +85°C)
- High stability over temperature
- Analog absolute angular-rate output
- Integrated low-pass filters
- Low power consumption
- Sleep mode
- Embedded power-down
- Embedded self-test
- High shock and vibration survivability
- ECOPACK[®] RoHS and "Green" compliant (see *Section 6*)

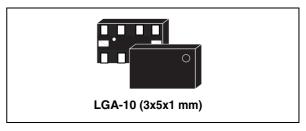
Applications

- Gaming applications
- Pointing devices, remote and game controllers
- Motion control with user interface
- Industrial and robotics

Description

The LY3200ALH is a high performance low-power single-axis micromachined gyroscope capable of measuring angular rate along yaw axis.

It provides excellent temperature stability and high resolution over extended operating temperature range (-40°C to +85°C).



The LY3200ALH has a full scale of ±2000 dps and is capable of detecting rates with a -3 dB bandwidth up to 140 Hz.

The device includes a sensing element composed of a single driving mass, kept in continuous oscillation and capable of reacting, based on the Coriolis principle, when an angular rate is applied.

A CMOS IC provides the measured angular rate to the external world through an analog output voltage, allowing high levels of integration and production trimming to better match sensing element characteristics.

ST's family of gyroscopes leverages on the mature and robust manufacturing process already used for the production of micro-machined accelerometers.

ST is already in the field with several hundred million sensors which have received excellent acceptance from the market in terms of quality, reliability and performance.

The LY3200ALH is available in a plastic land grid array (LGA) package, which ST successfully pioneered for accelerometers. Today ST has the widest manufacturing capability and strongest expertise in the world for production of sensors in plastic LGA packages.

Table 1. Device summary

| Order code | Temperature range (°C) | Package | Packing |
|-------------|------------------------|----------------|---------------|
| LY3200ALH | -40 to +85 | LGA-10 (3x5x1) | Tray |
| LY3200ALHTR | -40 to +85 | LGA-10 (3x5x1) | Tape and reel |

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PHASE

GENERATOR

AM03839v1

1 Block diagram and pin description

Figure 1. Block diagram

DRIVING MASS

Feedback loop

OHARGE
AMPLIRER

OUTZ

DEMODULATOR

DEMODULATOR

OUTZ

TRIMMING

CIRCUITS

GND

CLOCK

1.1 Pin description

Figure 2. Pin connection

REFERENCE

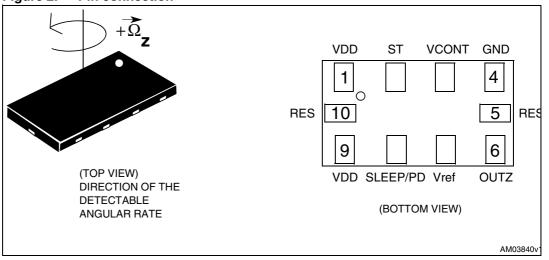


Table 2. Pin description

| Pin # | Pin name | Analog function |
|-------|----------|--|
| 1 | Vdd | Power supply |
| 2 | ST | Self-test (see <i>Table 6</i>) |
| 3 | VCONT | PLL filter connection |
| 4 | GND | 0V supply voltage |
| 5 | Res | Leave unconnected or connect to Vdd |
| 6 | OUTZ | Z axis output voltage |
| 7 | Vref | Reference voltage |
| 8 | SLEEP/PD | Sleep mode / power-down mode (see <i>Table 6</i>) |
| 9 | Vdd | Power supply |
| 10 | Res | Leave unconnected or connect to Vdd |

2 Mechanical and electrical specifications

2.1 Mechanical characteristics

Vdd = 3 V, T = 25 °C unless otherwise noted (a)

Table 3. Mechanical characteristics

| Symbol | Parameter | Test condition | Min. | Typ. ⁽¹⁾ | Max. | Unit |
|--------|--|------------------------|------|---------------------|------|---------|
| FS | Measurement range | | | ±2000 | | dps |
| So | Sensitivity ⁽²⁾ | | | 0.67 | | mV/dps |
| SoDr | Sensitivity change vs. temperature | Delta from 25°C | | 0.01 | | %/°C |
| Voff | Zero-rate level ⁽³⁾ | | | 1.5 | | V |
| OffDr | Zero-rate level change vs. temperature | Delta from 25°C | | 0.09 | | dps/°C |
| NL | Non linearity | Best fit straight line | | ±1 | | % FS |
| BW | Bandwidth ⁽³⁾ | | | 140 | | Hz |
| Vst | Self-test output change | | | 400 ⁽⁴⁾ | | mV |
| Rn | Rate noise density | | | 0.074 | | dps/√Hz |
| Тор | Operating temperature range | | -40 | | +85 | °C |

^{1.} Typical specifications are not guaranteed.

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^{2.} Sensitivity and zero-rate offset are not ratiometric to supply voltage.

^{3.} The product is capable of measuring angular rates extending from DC to the selected BW.

^{4.} Self test typical absolute value.

a. The product is factory calibrated at 3 V. The operational power supply range is specified in *Table 4*.

2.2 Electrical characteristics

Vdd = 3 V, T = 25 $^{\circ}$ C unless otherwise noted $^{(b)}$

Table 4. Electrical characteristics

| Symbol | Parameter | Test condition | Min. | Typ. ⁽¹⁾ | Max. | Unit |
|----------------------|------------------------------------|----------------|---------|---------------------|---------|------|
| Vdd | Supply voltage | | 2.7 | 3 | 3.6 | V |
| ldd | Supply current | | | 4.2 | | mA |
| IddSI | Supply current sleep mode | | | 2.2 | | mA |
| IddPdn | Supply current power- down mode | | | 5 | | μА |
| Vet | VST Self-test input | Logic 0 level | 0 | | 0.2*Vdd | V |
| VSI | | Logic 1 level | 0.8*Vdd | | Vdd | V |
| VPD | Power-down input | Logic 0 level | 0 | | 0.2*Vdd | V |
| VPD Fower-down input | Logic 1 level | 0.8*Vdd | | Vdd | V | |
| Тор | Operating temperature range | | -40 | | +85 | °C |

^{1.} Typical specifications are not guaranteed.

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b. The product is factory calibrated at 3 $\rm V$

3 Absolute maximum ratings

Stresses above those listed as "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 5. Absolute maximum ratings

| Symbol | Ratings | Maximum value | Unit |
|------------------|---|------------------|------|
| Vdd | Supply voltage | -0.3 to 6 | V |
| Vin | Input voltage on any control pin (SLEEP/PD, ST) | -0.3 to Vdd +0.3 | V |
| Α | Acceleration | 3000 for 0.5 ms | g |
| _ ^ | Acceleration | 10000 for 0.1 ms | g |
| T _{STG} | Storage temperature range | -40 to +125 | °C |
| ESD | Electrostatic discharge protection | 2 (HBM) | kV |



This is a mechanical shock sensitive device, improper handling can cause permanent damage to the part



This is an ESD sensitive device, improper handling can cause permanent damage to the part

Terminology LY3200ALH

4 Terminology

4.1 Sensitivity

An angular rate gyroscope is a device that produces a positive-going output voltage for counterclockwise rotation around the sensitive axis considered. Sensitivity describes the gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and time.

4.2 Zero-rate level

Zero-rate level describes the actual output signal if there is no angular rate present. The zero-rate level of precise MEMS sensors is, to some extent, a result of stress to the sensor and therefore zero-rate level can slightly change after mounting the sensor onto a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and time.

4.3 Self-test

Self-test allows testing of the mechanical and electrical part of the sensor, allowing the seismic mass to be moved by means of an electrostatic test-force. The self-test function is off when the ST pin is connected to GND. When the ST pin is tied to Vdd, an actuation force is applied to the sensor, emulating a definite Coriolis force. In this case the sensor output exhibits a voltage change in its DC level which is also dependent on the supply voltage. When ST is active, the device output level is given by the algebraic sum of the signals produced by the velocity acting on the sensor and by the electrostatic test-force. If the output signals change within the amplitude specified in *Table 3*, then the mechanical element is working properly and the parameters of the interface chip are within the defined specifications.

4.4 Sleep mode, self test and power down

The LY3200ALH enables advanced power-saving features thanks to the availability of three different operating modes. When the device is set in a Sleep mode configuration, the reading chain is completely turned off, resulting in low power consumption. In this condition the device turn-on time is significantly reduced, allowing simple external power cycling.

In accordance with the table below, the user can select the desired operating mode using two dedicated pins (ST and SLEEP/PD).

| Table 6. | Sleep mode and | Power-down | mode | configuration |
|----------|----------------|------------|------|---------------|
|----------|----------------|------------|------|---------------|

| Operating mode | ST pin | SLEEP/PD pin |
|----------------|--------|--------------|
| Normal mode | 0 | 0 |
| Sleep mode | 0 | 1 |
| Self-test | 1 | 0 |
| Power-down | 1 | 1 |

LY3200ALH Application hints

5 Application hints

Supply 2.20hm SLEEP/PD Vref LDO OUT Z GND 9 6 10 5 **TOP VIEW** 0 1 4 GND ST 10nF 470nF 10kOhm (TOP VIEW) DIRECTION OF THE DETECTABLE ANGULAR RATE R1 C1 GND AM03841v

Figure 3. LY3200ALH electrical connections and external components values

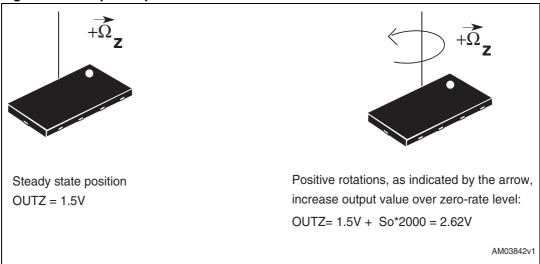
Power supply decoupling capacitors should be placed in combination with an LDO regulator (common design practice).

The LY3200ALH IC includes a PLL (phase-locked loop) circuit to synchronize driving and sensing interfaces. Capacitors and resistors must be added at **VCONT** pin 3 (as shown in *Figure 3*) to implement a low-pass filter.

Application hints LY3200ALH

5.1 Output response vs. rotation

Figure 4. Output response vs. rotation



5.2 Soldering information

The LGA package is compliant with the ECOPACK[®], RoHS and "Green" standard. It is qualified for soldering heat resistance according to JEDEC J-STD-020.

Leave "Pin 1 indicator" unconnected during soldering.

Land pattern and soldering recommendations are available at www.st.com

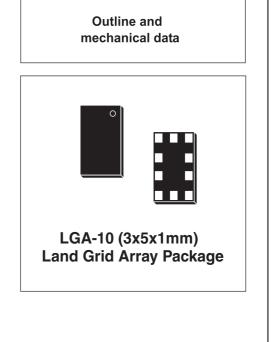
LY3200ALH Package information

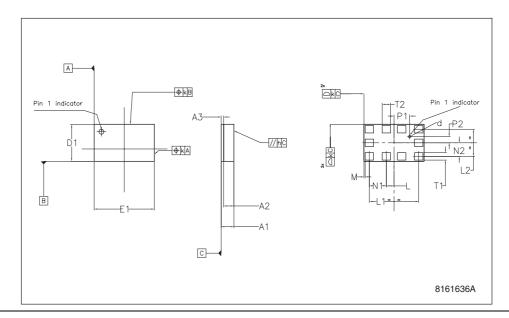
6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 5. LGA-10: mechanical data and package dimensions

| Dimensions | | | |
|------------|-------|-------|-------|
| Ref. | | mm | |
| Kei. | Min. | Тур. | Max. |
| A1 | | | 1.100 |
| A2 | | 0.855 | |
| A3 | | 0.200 | |
| D1 | 2.850 | 3.000 | 3.150 |
| E1 | 4.850 | 5.000 | 5.150 |
| L | | 0.635 | |
| L1 | | 4.100 | |
| L2 | | 2.200 | |
| N1 | | 1.415 | |
| N2 | | 1.100 | |
| М | | 0.075 | |
| P1 | | 1.300 | |
| P2 | | 0.500 | |
| T1 | | 0.600 | |
| T2 | | 0.700 | |
| d | | 0.200 | |
| k | | 0.050 | |
| h | | 0.100 | |





Revision history LY3200ALH

7 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|----------|-------------|
| 29-Oct-2009 | 1 | First issue |

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